L Number	Hits	Search Text	DB	Time stamp
1	17743	257/81,99,459,625,666-677,737,738,778-786,796.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:25
2	9800	257/177-181,584,688,689,705-707,712-722.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:26
3	7512	438/108,118,123,124,612-614,617,666.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:27
4	32445	257/81,99,459,625,666-677,737,738,778-786,796.ccls. OR 257/177-181,584,688,689,705-707,712-722.ccls. OR 438/108,118,123,124,612-614,617,666.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:27
5	1764	(257/81,99,459,625,666-677,737,738,778-786,796.ccls. OR 257/177-181,584,688,689,705-707,712-722.ccls. OR 438/108,118,123,124,612-614,617,666.ccls.) and ((flip NEAR chip) WITH package$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:55
6	51	((257/81,99,459,625,666-677,737,738,778-786,796.ccls. OR 257/177-181,584,688,689,705-707,712-722.ccls. OR 438/108,118,123,124,612-614,617,666.ccls.) and ((flip NEAR chip) WITH package$1)) and ((lead NEAR frame) WITH (die NEAR pad$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:55
7	2	("5885852" | "6177719").PN.	USPAT	2004/02/10 09:44
8	8	("5673479" | "5745984" | "5859475" | "5874784" | "5900676" | "5942794" | "5951305" | "6218731").PN.	USPAT	2004/02/10 09:46
9	335954	257/$.ccls. 438/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:55
10	3133	(257/$.ccls. 438/$.ccls.) and ((flip NEAR chip) WITH package$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:04
11	3737	(257/$.ccls. 438/$.ccls.) and ((flip NEAR chip) WITH packag$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 09:55
12	95	((257/$.ccls. 438/$.ccls.) and ((flip NEAR chip) WITH packag$3)) and ((lead NEAR frame) WITH (die NEAR pad$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:04
13	8671	(257/$.ccls. 438/$.ccls.) and (flip NEAR chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:20
14	0	((257/$.ccls. 438/$.ccls.) and (flip NEAR chip)) and ((lead NEAR frame) WITH (die NEAR pad$4) WITH concavit$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:06

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15	1639	((257/$.ccls. 438/$.ccls.) and (flip NEAR chip)) and (lead NEAR frame$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:20
16	0	(((257/$.ccls. 438/$.ccls.) and (flip NEAR chip)) and (lead NEAR frame$1)) and ((die NEAR pad$4) WITH concavit$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:06
17	52	(((257/$.ccls. 438/$.ccls.) and (flip NEAR chip)) and (lead NEAR frame$1)) and ((die NEAR pad$4) WITH (hollow open$3 hole$1 concavit$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:21
18	7	(((257/$.ccls. 438/$.ccls.) and (flip NEAR chip)) and (lead NEAR frame$1)) and ((die NEAR paddle$1) WITH (hollow open$3 hole$1 concavit$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:17
19	20324	(flip NEAR chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:20
20	2194	((flip NEAR chip)) and (lead NEAR frame$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:20
21	57	(((flip NEAR chip)) and (lead NEAR frame$1)) and ((die NEAR pad$4) WITH (hollow open$3 hole$1 concavit$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 10:21

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1	20324	flip NEAR chip	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 15:50
2	2193	(flip NEAR chip) and (lead NEAR frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 15:50
3	11	((flip NEAR chip) and (lead NEAR frame)) and (lead$1 NEAR2 (surround$3 around$3) NEAR2 (die NEAR pad$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:11
4	8	("5673479" | "5745984" | "5859475" | "5874784" | "5900676" | "5942794" | "5951305" | "6218731").PN.	USPAT	2004/02/10 16:02
5	553	chip WITH (first NEAR bond$3) WITH (second NEAR bond$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:09
6	10	(chip WITH (first NEAR bond$3) WITH (second NEAR bond$3)) and (first NEAR bump$1) WITH (second NEAR bump$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:09
7	197	(lead$1 NEAR2 (surround$3 around$3) NEAR2 (die NEAR pad$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:12
8	7	((lead$1 NEAR2 (surround$3 around$3) NEAR2 (die NEAR pad$3))) and (chip WITH (first NEAR bond$3) WITH (second NEAR bond$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:16
9	110	(chip WITH (first NEAR bond$3) WITH (second NEAR bond$3)) and (flip NEAR chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:28
10	30	((chip WITH (first NEAR bond$3) WITH (second NEAR bond$3)) and (flip NEAR chip)) and ((flip NEAR chip) and (lead NEAR frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:16
11	30	(chip WITH (first NEAR bond$3) WITH (second NEAR bond$3)) and ((flip NEAR chip) and (lead NEAR frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:27
12	12	((lead$1 NEAR2 (surround$3 around$3) NEAR2 (die NEAR pad$3))) and (flip NEAR chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/10 16:28
13	22	("4417266" | "4640047" | "4907067" | "5087961" | "5096852" | "5581122" | "5592025" | "5625222" | "5673479" | "5723899" | "5745984" | "5859471" | "5859475" | "5874784" | "5900676" | "5942794" | "5951305" | "5959356" | "6218731" | "6229200" | "6242281" | "6294100").PN.	USPAT	2004/02/10 16:47